Electronic Acknowledgement Receipt FES ID: 1186031 Application Number: 10685655 Confirmation Number: 5662 Photo mask set for forming multi-layered interconnection lines and Title of Invention: semiconductor device fabricated using the same First Named Inventor: Sung-Jin Kim Customer Number: 20575 Filer: Hosoon Lee/Stormi Davis Filer Authorized By: Hosoon Lee Attorney Docket Number: 8750-038 Receipt Date: 05-SEP-2006 Filing Date: 14-OCT-2003 Time Stamp: 17:12:27 Application Type: Utility International Application Number:

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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt. in due course.